



IMEC306.001AUS

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Szlufcik *et al.*
Appl. No. : 10/609,015
Filed : June 27, 2003
For : SEMICONDUCTOR ETCHING
PASTE AND THE USE THEREOF
FOR LOCALIZED ETCHING OF
SEMICONDUCTOR
SUBSTRATES
Examiner : Vinh, L.
Group Art Unit : 1765

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

March 6, 2006

(Date)

Rose M. Thiessen, Reg. No. 40,202

DO NOT ENTER

LV
3/16/05

AMENDMENT AFTER FINAL

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed January 6, 2006, Applicants respectfully request that the Examiner enter the following amendments, consider the following remarks, and issue an Advisory Action.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.